

04-25-2001

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101683771

ORIGINAL DOCUMENTS OR COPY THEREOF.

1. Name of conveying party(ies): 04/13/01

(a) Young-Gu Kang

Additional name(s) of conveying party(ies) attached?
 Yes No

2. Name and address of receiving party(ies):

Name: Samsung Electronics Co., Ltd.
416, Maetan-dong, Paldal-ku
Suwon, Kyunggi-do
Republic of Korea

*J1036 U.S. PTO
09/834498
04/13/01*

3. Nature of Conveyance:

Assignment Merger
 Security Agreement Change of Name
 Other _____

Execution Date: March 26, 2001

Name and address of receiving party(ies):

Name: _____
 Street Address: _____
 City: _____ State: _____ Zip: _____
 Country: _____

Additional name(s) & address(es) attached?
 Yes No

4. Application number(s) or patent number(s): 09/834498

If this document is being filed together with a new application, the execution date of the application is: April 13, 2001

A. Patent Application No.(s) - Unassigned

Title: Semiconductor Memory Integrated Circuit
Operating At Different Test Modes

B. Patent No.(s)

N/A

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: David W. Heid

Internal Address: SKJERVEN MORRILL MacPHERSON LLP

Street Address: 25 METRO DRIVE, SUITE 700

City SAN JOSE State CA Zip 95110

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00

Authorized to be charged to Deposit Account 19-2386
 Charge Deposit Account 19-2386 for any additional fees required for this conveyance and credit deposit account 19-2386 any amounts overpaid

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8. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Carmen C. Cook 42.433 CAROL COOK Apr. 13, 01
 Name of Person Signing Signature Date

Total number of pages comprising cover sheet: 2

ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, I, **Young-Gu, Kang** of **453-5, Hasankok-dong, Hanam-shi, Kyunggi-do, Republic of Korea**, hereby sell, assign and transfer to **Samsung Electronics Co., Ltd.**, a Korean corporation, having a place of business at **416, Maetan-dong, Paldal-ku, Suwon, Kyunggi-do, Republic of Korea**, its successors and assigns, the entire right, title and interest throughout the world in my invention in

**SEMICONDUCTOR MEMORY INTEGRATED CIRCUIT
OPERATING AT DIFFERENT TEST MODES**

for which I have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and I request the Commissioner of Patents and Trademarks to issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 26th day of March, 2001.

Young-Gu Kang
Young-Gu Kang